

MGF2430A

MICROWAVE POWER GaAs FET

DESCRIPTION

The MGF2430A, power GaAs FET with an N-channel schottky gate, is designed for use in S to Ku band amplifiers.

FEATURES

- High output power
 $P_{1dB} = 30.5 \text{ dBm (TYP.) @ 14.5 GHz}$
- High power gain
 $G_{LP} = 6.5 \text{ dB (TYP.) @ 14.5 GHz}$
- High power added efficiency
 $\eta_{add} = 27\% \text{ (TYP.) @ 14.5 GHz, } P_{1dB}$

APPLICATION

S to Ku band power amplifiers.

QUALITY GRADE

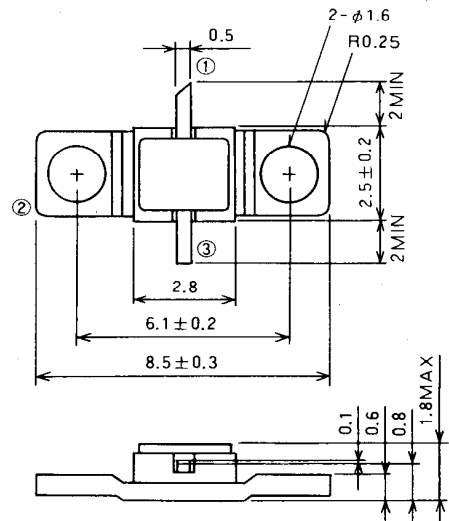
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RECOMMENDED BIAS CONDITIONS

- $V_{DS} = 10V$
- $I_D = 300mA$
- Refer to Bias Procedure

OUTLINE DRAWING

Unit: millimeters



- ① GATE
- ② SOURCE
- ③ DRAIN

GF-17

KTTIC

ABSOLUTE MAXIMUM RATINGS (Ta = 25°C)

| Symbol | Parameter | Ratings | Unit |
|-----------|----------------------------|------------|------|
| V_{GDO} | Gate to drain voltage | -15 | V |
| V_{GSO} | Gate to source voltage | -15 | V |
| I_D | Drain current | 800 | mA |
| I_{GR} | Reverse gate current | -2.4 | mA |
| I_{GF} | Forward gate current | 10.0 | mA |
| P_T | Total power dissipation *1 | 5.0 | W |
| T_{ch} | Channel temperature | 175 | °C |
| T_{stg} | Storage temperature | -65 ~ +175 | °C |

*1: $T_C = 25^\circ C$

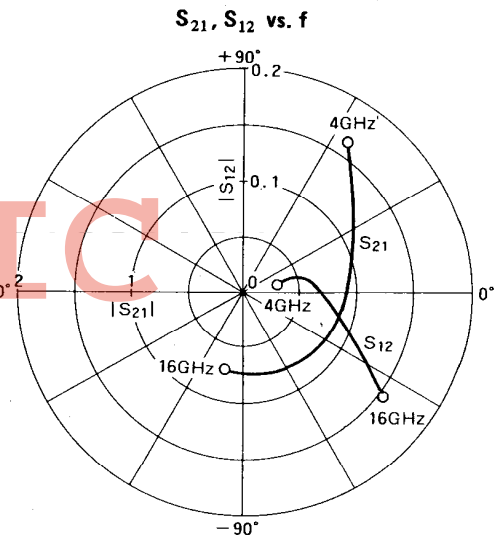
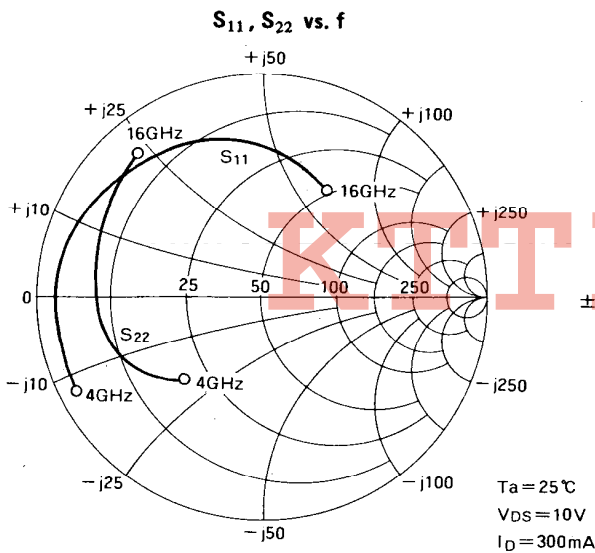
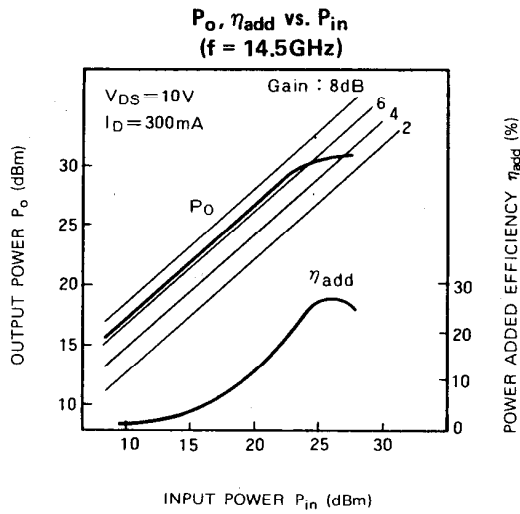
ELECTRICAL CHARACTERISTICS (Ta = 25°C)

| Symbol | Parameter | Test conditions | Limits | | | Unit |
|----------------|--------------------------------------|---|--------|------|-----|------|
| | | | Min | Typ | Max | |
| I_{DSS} | Saturated drain current | $V_{DS} = 3V, V_{GS} = 0V$ | 400 | 600 | 800 | mA |
| $V_{GS(off)}$ | Gate to source cut-off voltage | $V_{DS} = 3V, I_D = 2mA$ | -1 | -2.5 | -4 | V |
| g_m | Transconductance | $V_{DS} = 3V, I_D = 300mA$ | 200 | 260 | — | mS |
| P_{1dB} | Output power at 1dB gain compression | $V_{DS} = 10V, I_D = 300mA, f = 14.5GHz,$ | 29.0 | 30.5 | — | dBm |
| G_{LP} | Linear power gain | | 5.5 | 6.5 | — | dB |
| η_{add} | Power added efficiency at P_{1dB} | | — | 27 | — | % |
| $R_{th(ch-c)}$ | Thermal resistance *1 | ΔV_f method | — | — | 30 | °C/W |

*1: Channel to case

MICROWAVE POWER GaAs FET

TYPICAL CHARACTERISTICS (Ta=25°C)



S PARAMETERS (Ta=25°C, V_{DS}=10V, I_D=300mA)

| f (GHz) | S Parameters (TYP.) | | | | | | | | K | MSG/MAG dB |
|------------|---------------------|--------------|-----------------|--------------|-----------------|--------------|-----------------|--------------|-------|---------------|
| | S ₁₁ | | S ₂₁ | | S ₁₂ | | S ₂₂ | | | |
| | Magn. | Angle (deg.) | Magn. | Angle (deg.) | Magn. | Angle (deg.) | Magn. | Angle (deg.) | | |
| 4 | 0.934 | -153.0 | 1.641 | 57.0 | 0.030 | 18.0 | 0.513 | -132.0 | 0.501 | 17.4 |
| 6 | 0.900 | -168.0 | 1.109 | 34.0 | 0.035 | 19.0 | 0.620 | -142.0 | 0.969 | 15.0 |
| 8 | 0.853 | 173.0 | 0.927 | 13.0 | 0.043 | 20.0 | 0.699 | -161.5 | 0.811 | 13.3 |
| 10 | 0.813 | 153.0 | 0.830 | -13.0 | 0.052 | 18.5 | 0.723 | 180.0 | 1.008 | 11.5 |
| 12 | 0.750 | 131.5 | 0.788 | -41.0 | 0.058 | 13.0 | 0.754 | 162.0 | 1.331 | 7.9 |
| 14 | 0.790 | 105.0 | 0.730 | -69.0 | 0.083 | -7.5 | 0.783 | 146.0 | 1.108 | 7.4 |
| 16 | 0.530 | 61.0 | 0.689 | -104.0 | 0.153 | -37.0 | 0.836 | 132.0 | 0.681 | 6.5 |

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